

23. Hydrosilylation Derived Silicon-Containing Hydrocarbon-Based Polymers for Low Loss Dielectric Applications

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Abstract: For the next-generation wireless communication systems using millimeter-wave frequencies, polymer materials exhibiting low dielectric constants (D_k) and low loss tangents (D_f) are required to reduce transmission loss. In this study, silicon-containing hydrocarbon-based polymers were synthesized for such high-frequency dielectric applications¹. They were prepared by Karstedt-catalyzed polyaddition of dihydrosilanes with diyne or diene monomers². Their hydrocarbon backbones and silicon-containing units were designed to reduce molecular polarizability, increase free volume, and suppress moisture adsorption³. The dielectric properties were evaluated at 20 and 40 GHz using a cavity resonator, and the polymers exhibited low D_k and low D_f . In particular, the diyne-derived polymers showed lower D_f than the diene-derived polymers, suggesting that backbone rigidity suppresses dipolar relaxation at higher frequencies. These results indicate that silicon-containing hydrocarbon-based polymers are promising low-loss dielectric materials for advanced communication technologies.

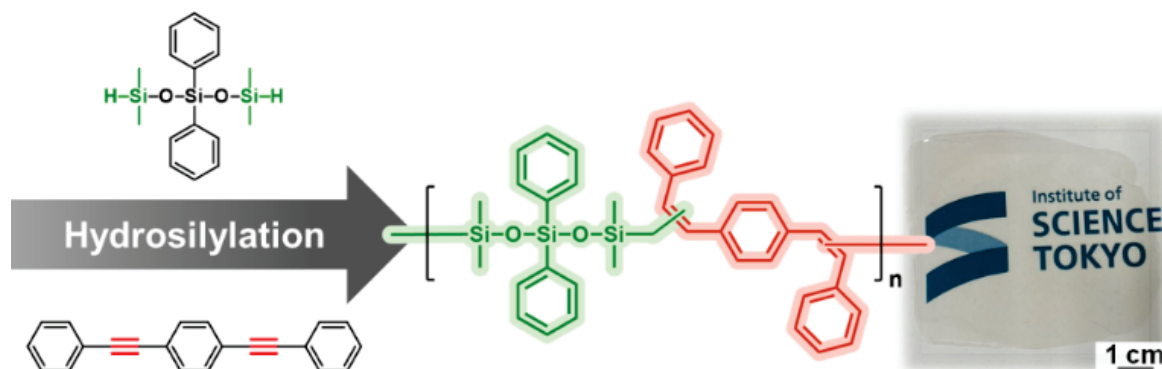


Figure 1 Silicon-containing hydrocarbon-based polymer.

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Key words: Silicon-containing polymer, Hydrosilylation reaction, Low dielectric loss

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